

**IN THE SPECIFICATION:**

Please amend paragraphs [0040] and [0042] of the specification as follows:

[0040] According to the invention, the first TBC layer 4 is formed on the substrate 2, and exemplarily on a bond coating 3 covering the ~~sub2~~ substrate 2, by introducing relatively dense, presintered powder ~~part~~particles 12 into the jet 9. The powder particles 12 used for producing the first layer 4 have been formed by means of a process as described hereinabove that constitutes an agglomeration and sintering procedure.

[0042] A second layer 5 is subsequently formed by ~~the introduction of the first powder~~ introducing powder particles 12 with a different microstructure than experienced in the first layer 4. The powder particles used to produce the second layer have a more open, porous structure than the first powder particles. Preferably, they have been produced in the way described earlier in the text; that is, by an agglomeration/HOSP process (Homogeneous Oven Spherical Powder) which is a well-known process in the art.